# imall

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# HIGH ISOLATION VOLTAGE DARLINGTON TRANSISTOR SOP MULTI PHOTOCOUPLER SERIES

NEPOC Series

#### DESCRIPTION

The PS2702-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon darlingtonconnected phototransistor.

This is mounted in a plastic SOP (Small Out-line Package) for high density applications.

This package has shield effect to cut off ambient light.

#### FEATURES

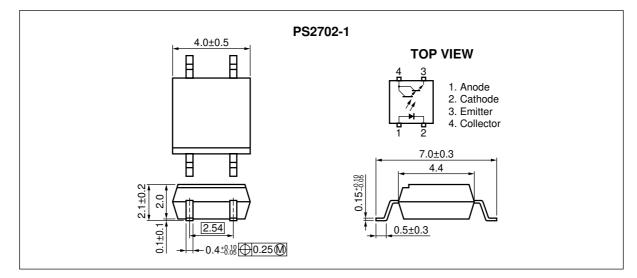
- High current transfer ratio (CTR = 2 000% TYP.)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- · Small and thin (SOP) package
- High-speed switching (tr, tf = 200 µs TYP.)
- Ordering number of taping product: PS2702-1-F3, F4
- Safety standards
  - UL approved: File No. E72422
  - BSI approved: File No. 8219/8220
  - CSA approved: File No. CA 101391
  - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

### **APPLICATIONS**

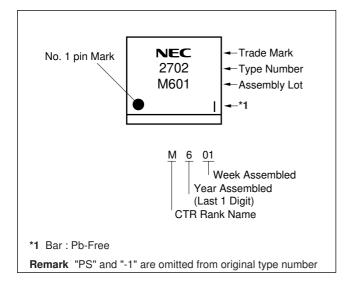
- Hybrid IC
- Telephone/FAX
- FA/OA equipment
- Programmable logic controllers

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

# PACKAGE DIMENSIONS (in millimeters)



# ★ MARKING EXAMPLE



# ★ ORDERING INFORMATION

| Part Number   | Order Number    | Solder Plating<br>Specification | Packing Style                | Safety Standard<br>Approval | Application Part<br>Number*1 |
|---------------|-----------------|---------------------------------|------------------------------|-----------------------------|------------------------------|
| PS2702-1      | PS2702-1-A      | Pb-Free                         | Magazine case 100 pcs        | Standard products           | PS2702-1                     |
| PS2702-1-F3   | PS2702-1-F3-A   |                                 | Embossed Tape 3 500 pcs/reel | (UL, BSI, CSA               |                              |
| PS2702-1-F4   | PS2702-1-F4-A   |                                 |                              | approved)                   |                              |
| PS2702-1-V    | PS2702-1-V-A    |                                 | Magazine case 100 pcs        | DIN EN60747-5-2             |                              |
| PS2702-1-V-F3 | PS2702-1-V-F3-A |                                 | Embossed Tape 3 500 pcs/reel | (VDE0884 Part2)             |                              |
| PS2702-1-V-F4 | PS2702-1-V-F4-A |                                 |                              | Approved (Option)           |                              |

\*1 For the application of the Safety Standard, following part number should be used.

|                               | Parameter                    | Symbol | Ratings     | Unit    |
|-------------------------------|------------------------------|--------|-------------|---------|
| Diode                         | Forward Current (DC)         | lf     | 50          | mA      |
|                               | Reverse Voltage              | VR     | 6.0         | V       |
|                               | Power Dissipation Derating   | ⊿Po/°C | 0.8         | mW/°C   |
|                               | Power Dissipation            | PD     | 80          | mW      |
|                               | Peak Forward Current *1      | IFP    | 1           | А       |
| Transistor                    | Collector to Emitter Voltage | VCEO   | 40          | V       |
|                               | Emitter to Collector Voltage | VECO   | 6           | V       |
|                               | Collector Current            | lc     | 200         | mA      |
|                               | Power Dissipation Derating   | ⊿Pc/°C | 1.5         | mW/°C   |
|                               | Power Dissipation            | Pc     | 150         | mW      |
| Isolation Voltage *2          |                              | BV     | 3 750       | Vr.m.s. |
| Operating Ambient Temperature |                              | TA     | –55 to +100 | °C      |
| Storage Temperature           |                              | Tstg   | –55 to +150 | °C      |

# ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

\*1 PW = 100 *µ*s, Duty Cycle = 1%

\*2 AC voltage for 1 minute at  $T_A = 25^{\circ}C$ , RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

|            | Parameter                            | Symbol    | Conditions  | MIN.             | TYP.  | MAX. | Unit |
|------------|--------------------------------------|-----------|---|------------------|-------|------|------|
| Diode      | Forward Voltage                      | VF        | IF = 5 mA   |                  | 1.1   | 1.4  | V    |
|            | Reverse Current                      | IR        | V <sub>R</sub> = 5 V  |                  |       | 5    | μA   |
|            | Terminal Capacitance                 | Ct        | V = 0 V, f = 1 MHz  |                  | 30    |      | pF   |
| Transistor | Collector to Emitter Dark<br>Current | Iceo      | IF = 0 mA, VCE = 40 V   |                  |       | 400  | nA   |
| Coupled    | Current Transfer Ratio               | CTR       | IF = 1 mA, VCE = 2 V  | 200              | 2 000 |      | %    |
|            | Collector Saturation<br>Voltage      | VCE (sat) | l⊧ = 1 mA, lc = 2 mA  |                  |       | 1.0  | V    |
|            | Isolation Resistance                 | RI-0      | VI-O = 1 KVDC   | 10 <sup>11</sup> |       |      | Ω    |
|            | Isolation Capacitance                | CI-0      | V = 0 V, f = 1 MHz  |                  | 0.4   |      | pF   |
|            | Rise Time <sup>*2</sup>              | tr        | $V_{CC} = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ R}_{L} = 100 \Omega$ |                  | 200   |      | μS   |
|            | Fall Time *2                         | tr        |   |                  | 200   |      |      |

# ELECTRICAL CHARACTERISTICS (TA = 25 °C)

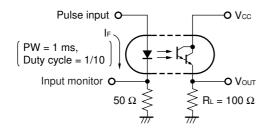
\*1 CTR rank

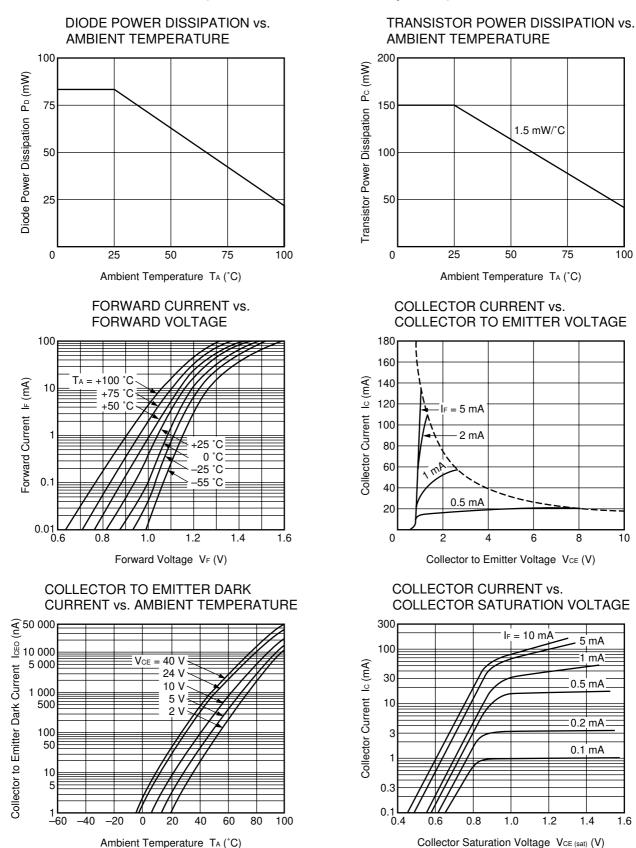
K: 2 000 to (%)

L: 700 to 3 400 (%)

M: 200 to 1 000 (%)

\*2 Test circuit for switching time



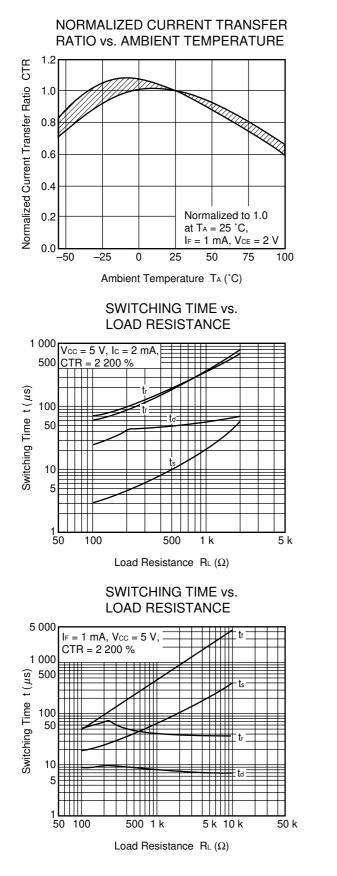


### TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

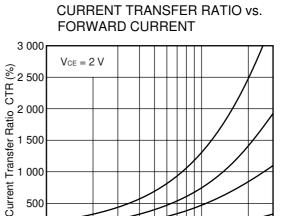
Remark The graphs indicate nominal characteristics.

Data Sheet PN10241EJ02V0DS

300



Remark The graphs indicate nominal characteristics.

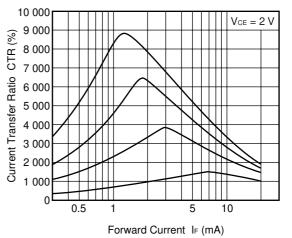


50 Forward Current IF ( $\mu$ A)

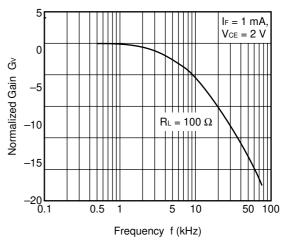
0E

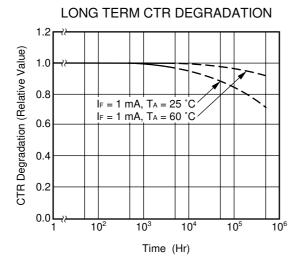


100



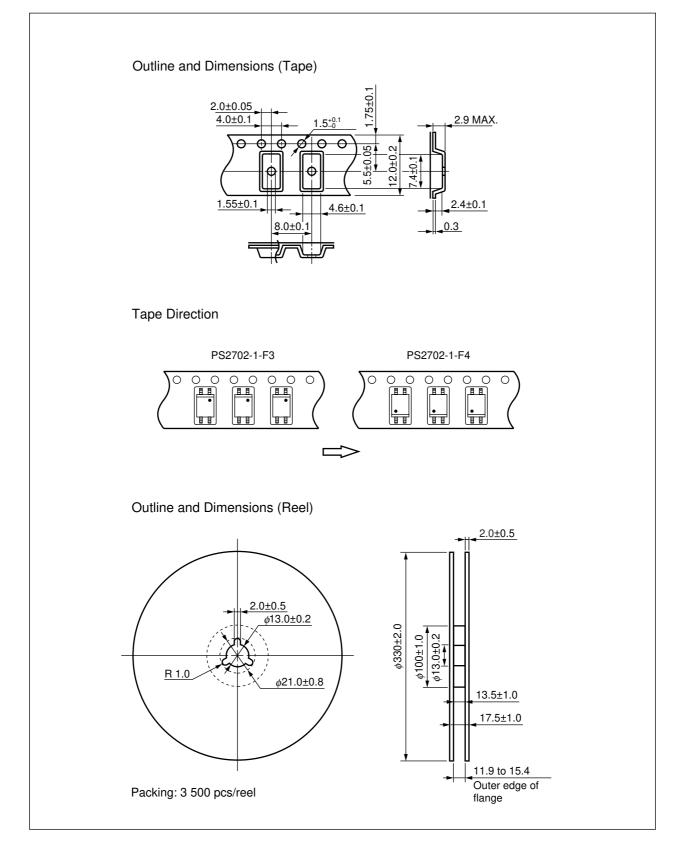
FREQUENCY RESPONSE





Remark The graph indicates nominal characteristics.

# TAPING SPECIFICATIONS (in millimeters)



# NOTES ON HANDLING

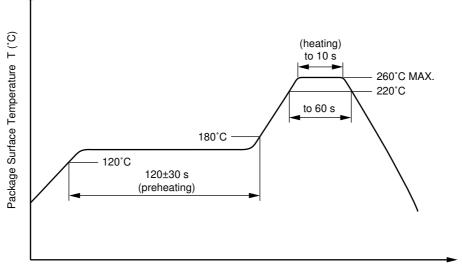
#### 1. Recommended soldering conditions

#### (1) Infrared reflow soldering

- · Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### ★ (3) Soldering by soldering iron

| Peak temperature (lead part temperature) | 350°C or below  |
|--|---|
| <ul> <li>Time (each pins)</li> </ul>     | 3 seconds or less   |
| • Flux                                   | Rosin flux containing small amount of chlorine (The flux with a |
|  | maximum chlorine content of 0.2 Wt% is recommended.)            |

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

#### (4) Cautions

#### Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

#### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

# ★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

## **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

# SPECIFICATION OF VDE MARKS LICENSE DOCUMENT (VDE0884)

| Parameter  | Symbol               | Speck                                | Unit                                   |
|--|----------------------|--------------------------------------|--|
| Application classification (DIN VDE 0109) for rated line voltages $\leq$ 300 Vr.m.s. for rated line voltages $\leq$ 600 Vr.m.s.  |                      | IV<br>III                            |  |
| Climatic test class (DIN IEC 68 Teil 1/09.80)  |                      | 55/100/21                            |  |
| Dielectric strength<br>maximum operating isolation voltage<br>Test voltage (partial discharge test, procedure a for type test and random test)<br>$U_{pr} = 1.2 \times U_{IORM}, P_d < 5 \text{ pC}$                         | Uiorm<br>Upr         | 710<br>850                           | V <sub>peak</sub><br>V <sub>peak</sub> |
| Test voltage (partial discharge test, procedure b for all devices test) $U_{\text{pr}}$ = 1.6 $\times$ $U_{\text{IORM}},P_{\text{d}}<5pC$  | Upr                  | 1 140                                | V <sub>peak</sub>                      |
| Highest permissible overvoltage  | Utr                  | 6 000                                | V <sub>peak</sub>                      |
| Degree of pollution (DIN VDE 0109)   |                      | 2                                    |  |
| Clearance distance   |                      | > 5                                  | mm                                     |
| Creepage distance  |                      | > 5                                  | mm                                     |
| Comparative tracking index (DIN IEC 112/VDE 0303 part 1)   | CTI                  | 175                                  |  |
| Material group (DIN VDE 0109)  |                      | III a                                |  |
| Storage temperature range  | Tstg                 | –55 to +150                          | °C                                     |
| Operating temperature range  | TA                   | -55 to +100                          | °C                                     |
| Isolation resistance, minimum value<br>$V_{IO} = 500 \text{ V dc at } T_A = 25 \text{ °C}$<br>$V_{IO} = 500 \text{ V dc at } T_A MAX. at least 100 \text{ °C}$   | Ris MIN.<br>Ris MIN. | 10 <sup>12</sup><br>10 <sup>11</sup> | Ω<br>Ω                                 |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve)<br>Package temperature<br>Current (input current IF, Psi = 0)<br>Power (output or total power dissipation)<br>Isolation resistance | Tsi<br>Isi<br>Psi    | 150<br>200<br>300                    | °C<br>mA<br>mW                         |
| $V_{IO} = 500 \text{ V dc at } T_A = 175 \text{ °C} \text{ (Tsi)}$   | Ris MIN.             | 10 <sup>9</sup>                      | Ω                                      |

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M8E 00.4-0110

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|-----------------------|--|
|                       | • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.  |
|                       | <ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of<br/>materials that contain arsenic and other such industrial waste materials.</li> </ol>                      |
|                       | <ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the<br/>product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol> |
|                       | Do not burn, destroy, cut, crush, or chemically dissolve the product.  |
|                       | Do not lick the product or in any way allow it to enter the mouth.   |

► For further information, please contact

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CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance<br>per RoHS | Concentration Limit per RoHS<br>(values are not yet fixed) | Concentration contained<br>in CEL devices |         |
|----------------------------------|--|---|---------|
| Lead (Pb)                        | < 1000 PPM   | -A -AZ<br>Not Detected (*)                |         |
| Mercury                          | < 1000 PPM   | Not De                                    | etected |
| Cadmium                          | < 100 PPM  | Not Detected                              |         |
| Hexavalent Chromium              | < 1000 PPM   | Not Detected                              |         |
| РВВ                              | < 1000 PPM   | Not Detected                              |         |
| PBDE                             | < 1000 PPM   | Not Detected                              |         |

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